#### 02/17/2017 504234663

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT4281340

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KEI TAKAHASHI	12/13/2016
ROH YAMAMOTO	12/13/2016

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15387273

#### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	12732-1781001
NAME OF SUBMITTER:	JANELLE A. JACKSON
SIGNATURE:	/Janelle A. Jackson/
DATE SIGNED:	02/17/2017

**Total Attachments: 1** 

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**PATENT REEL: 041290 FRAME: 0558** 504234663

# **ASSIGNMENT**

For valuable consideration, We, <u>Kei TAKAHASHI of Isehara</u>, <u>Kanagawa</u>, <u>Japan and Roh YAMAMOTO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE, DRIVER IC, AND
ELECTRONIC DEVICE, filed December 21, 2016 , and assigned U.S. Serial
Number, and we authorize and request the attorneys appointed in said application
to hereafter complete this assignment by inserting above the filing date and serial number of said application
when known; this assignment including said application, any and all United States and foreign patents,
utility models, and design registrations granted for any of said inventions or improvements, and the right to
claim priority based on the filing date of said application under the International Convention for the
Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all
other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its
own name for patents, utility models, design registrations and like rights of exclusion and for inventors'
certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal
representatives and assigns, without further compensation to perform such lawful acts and to sign such
further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may
reasonably request to effectuate fully this assignment.
Signature Key Takahashi
Name: Kei TAKAHASHI
Name:         Kei TAKAHASHI           Date:          ≥/(3 / 2₀)   6
Signature Poh Tamanoto
Name: Roh YAMAMOTO  Date: [2/(3/2016]
Date: (2/(3/2016

**RECORDED: 02/17/2017** 

PATENT REEL: 041290 FRAME: 0559